

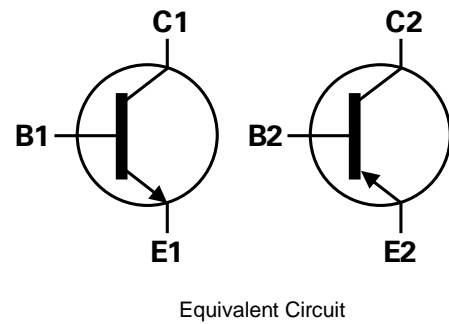
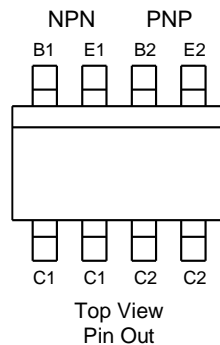
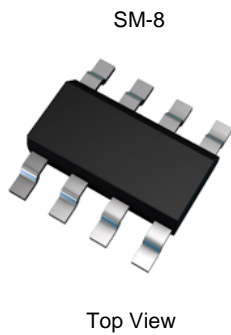
### Features

- NPN Transistor
  - $BV_{CEO} > 20V$
  - Low Saturation Voltage  $V_{CE(sat)} < 150mV @ 1A$
- PNP Transistor
  - $BV_{CEO} > -20V$
  - Low Saturation Voltage  $V_{CE(sat)} < -200mV @ -1A$
- Packaged in SM-8 (8 LEAD SOT223)
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The ZDT6718Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

### Mechanical Data

- Package: SM-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.117 grams (Approximate)

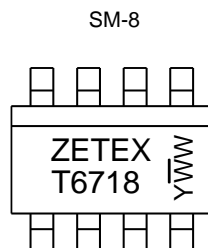


### Ordering Information (Note 4)

Orderable Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
ZDT6718QTA	SM-8	T6718	7	12	1,000	Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

### Marking Information



ZETEX = Product Brand Logo  
 T6718 = Product Type Marking Code  
 YWW = Date Code Marking  
 Y = Last Digit of Year (ex: 5 = 2025)  
 WW = Week Code (01 to 53)

**Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	NPN	PNP	Unit
Collector-Base Voltage	V <sub>CBO</sub>	20	-20	V
Collector-Emitter Voltage	V <sub>CEO</sub>	20	-20	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	-7	V
Continuous Collector Current	I <sub>C</sub>	2	-1.5	A
Peak Pulse Current (Note 5)	I <sub>CM</sub>	6	-6	A

**Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

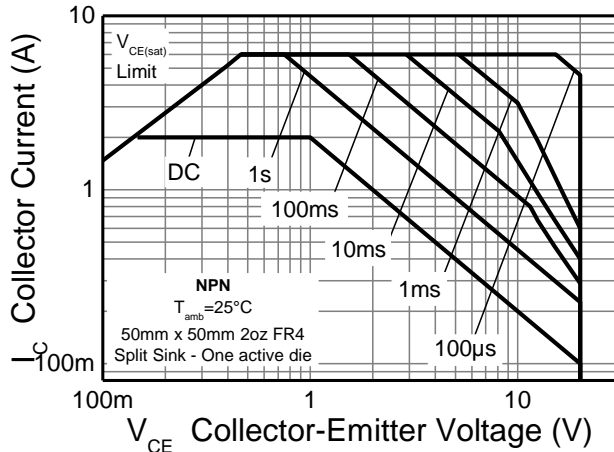
Characteristic	Symbol	Value	Unit
Collector Power Dissipation	P <sub>D</sub>	(Note 5) 2	W
		(Note 6) 2.5	
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	(Note 5) 62.5	°C/W
		(Note 6) 50	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**ESD Ratings** (Note 7)

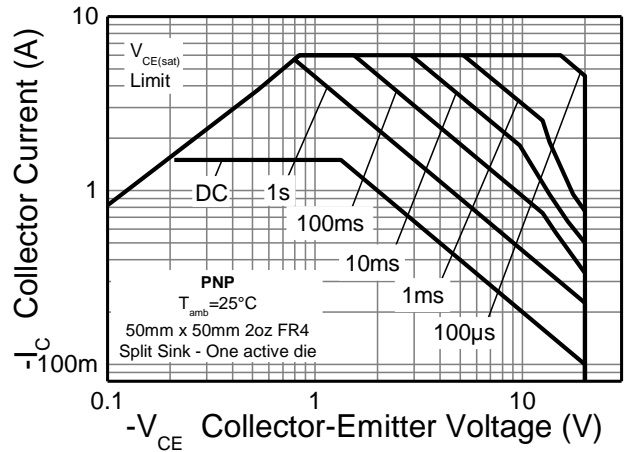
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
5. For a device with any single die active and mounted with the collector lead on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
  6. Same as note 5, except both die are active and equally sharing power.
  7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

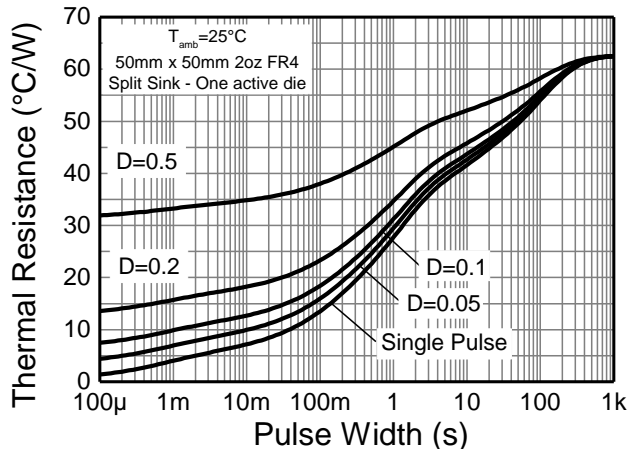
**Thermal Characteristics and Derating Information**



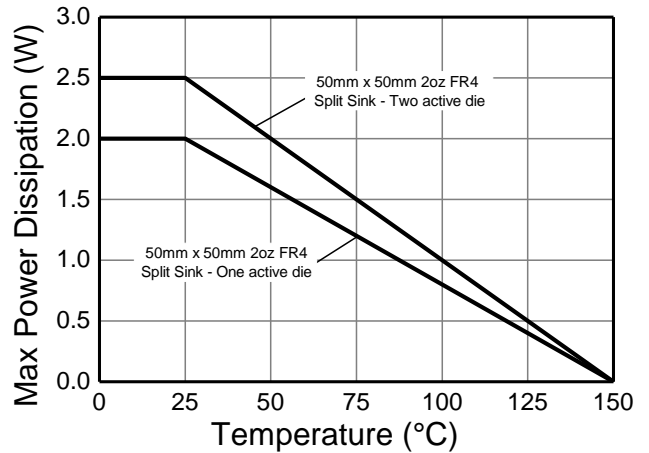
**Fig.1 Safe Operating Area**



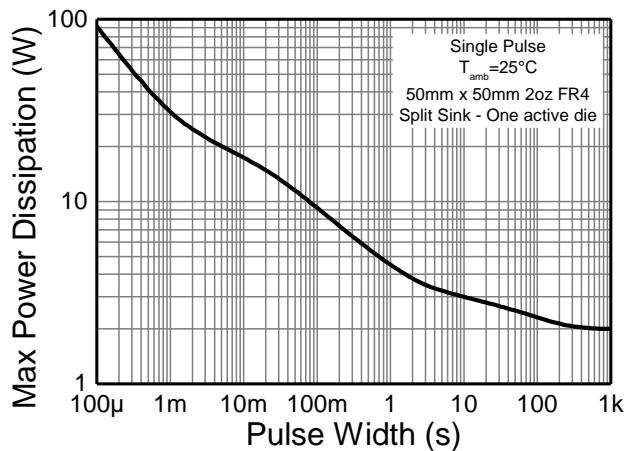
**Fig.2 Safe Operating Area**



**Fig.3 Transient Thermal Impedance**



**Fig.4 Derating Curve**



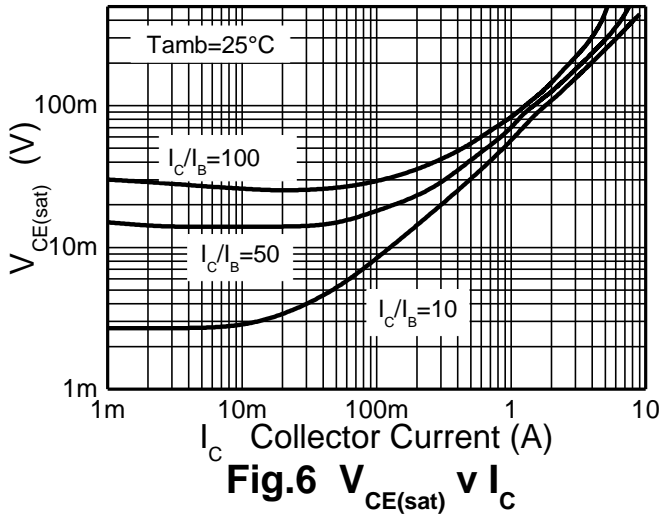
**Fig.5 Pulse Power Dissipation**

**NPN - Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

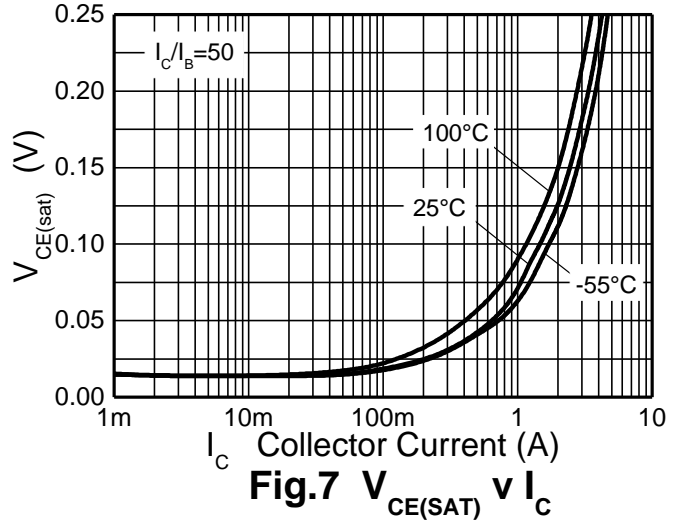
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CB0</sub>	20	100	—	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 8)	BV <sub>CEO</sub>	20	27	—	V	I <sub>C</sub> = 10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.3	—	V	I <sub>E</sub> = 100μA
Collector Cutoff Current	I <sub>CBO</sub>	—	—	100	nA	V <sub>CB</sub> = 16V
Emitter Cutoff Current	I <sub>EBO</sub>	—	—	100	nA	V <sub>EB</sub> = 4V
Collector-Emitter Cutoff Current	I <sub>CES</sub>	—	—	100	nA	V <sub>CES</sub> = 16V
DC Current Transfer Static Ratio (Note 8)	h <sub>FE</sub>	200	400	—	—	I <sub>C</sub> = 10mA, V <sub>CE</sub> = 2V
		300	450	—		I <sub>C</sub> = 200mA, V <sub>CE</sub> = 2V
		200	360	—		I <sub>C</sub> = 2A, V <sub>CE</sub> = 2V
		100	180	—		I <sub>C</sub> = 6A, V <sub>CE</sub> = 2V
Collector-Emitter Saturation Voltage (Note 8)	V <sub>CE(sat)</sub>	—	7	15	mV	I <sub>C</sub> = 0.1A, I <sub>B</sub> = 10mA
		—	70	150		I <sub>C</sub> = 1A, I <sub>B</sub> = 10mA
		—	130	200		I <sub>C</sub> = 2.5A, I <sub>B</sub> = 50mA
Base-Emitter Saturation Voltage (Note 8)	V <sub>BE(sat)</sub>	—	0.89	1	V	I <sub>C</sub> = 2.5A, I <sub>B</sub> = 50mA
Base-Emitter Turn-On Voltage (Note 8)	V <sub>BE(on)</sub>	—	0.79	1	V	I <sub>C</sub> = 2.5A, V <sub>CE</sub> = 2V
Transitional Frequency	f <sub>T</sub>	100	140	—	MHz	I <sub>C</sub> = 50mA, V <sub>CE</sub> = 10V
Output Capacitance	C <sub>obo</sub>	—	23	30	pF	V <sub>CB</sub> = 10V, f = 1MHz
Switching Time	t <sub>on</sub>	—	170	—	ns	V <sub>CC</sub> = 10V, I <sub>C</sub> = 1A, I <sub>B1</sub> = -I <sub>B2</sub> = 10mA
	t <sub>off</sub>	—	400	—	ns	

Note: 8. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

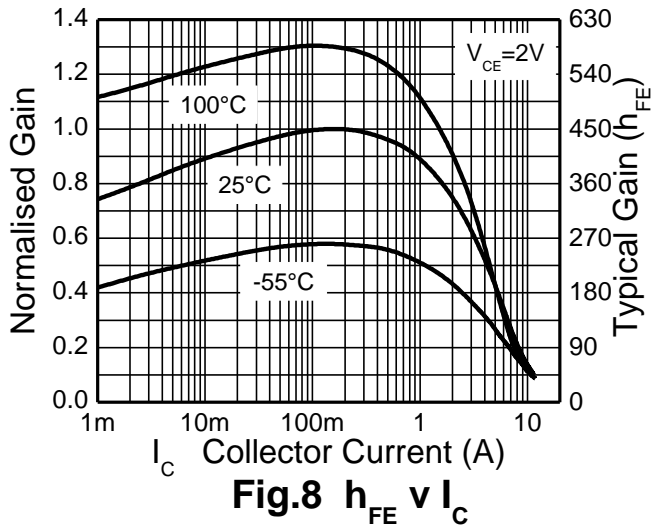
**NPN - Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



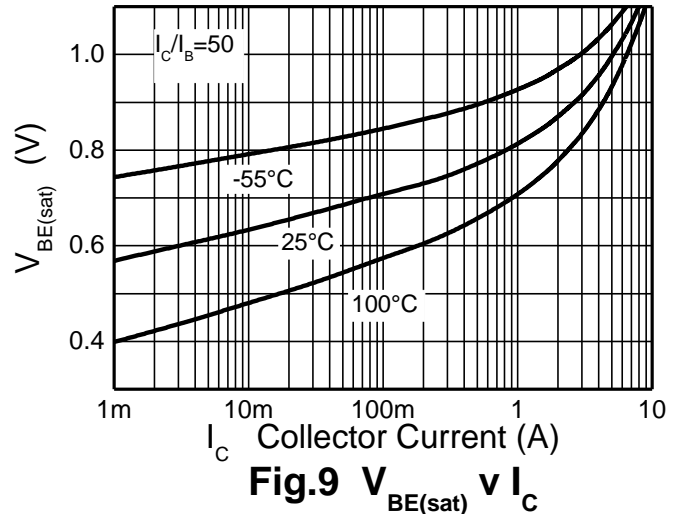
**Fig.6**  $V_{CE(sat)} \ v \ I_C$



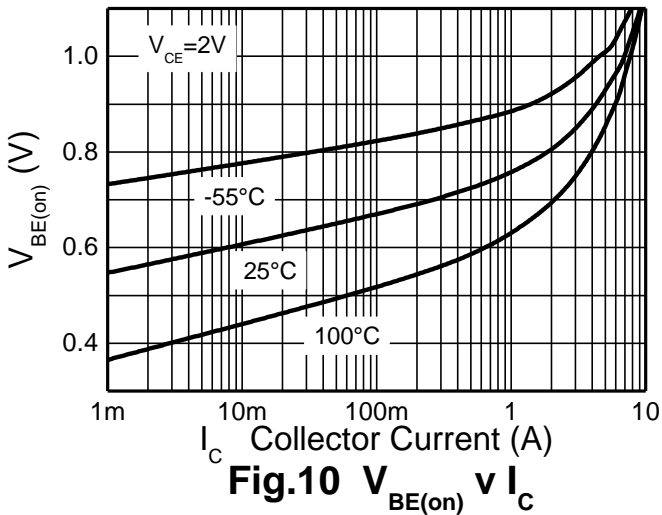
**Fig.7**  $V_{CE(sat)} \ v \ I_C$



**Fig.8**  $h_{FE} \ v \ I_C$



**Fig.9**  $V_{BE(sat)} \ v \ I_C$



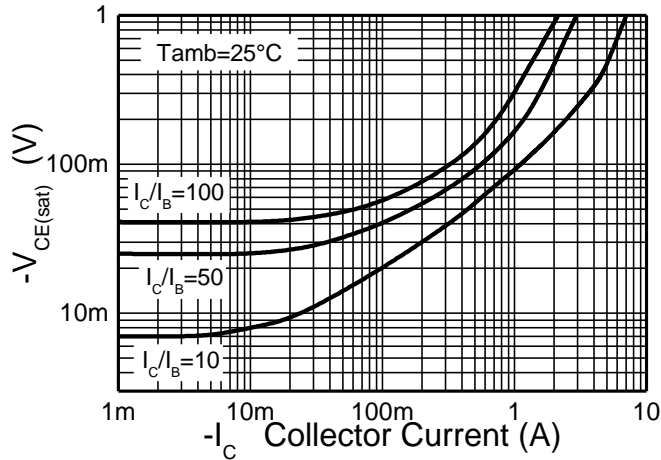
**Fig.10**  $V_{BE(on)} \ v \ I_C$

**PNP - Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

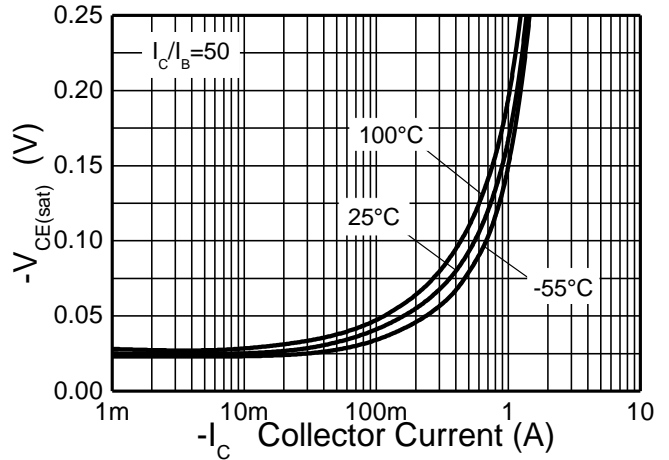
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-20	-65	—	V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV <sub>CEO</sub>	-20	-55	—	V	I <sub>C</sub> = -10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.8	—	V	I <sub>E</sub> = -100μA
Collector Cutoff Current	I <sub>CBO</sub>	—	—	-100	nA	V <sub>CB</sub> = -15V
Emitter Cutoff Current	I <sub>EBO</sub>	—	—	-100	nA	V <sub>EB</sub> = -5.6V
Collector-Emitter Cutoff Current	I <sub>CES</sub>	—	—	100	nA	V <sub>CES</sub> = 15V
DC Current Transfer Static Ratio (Note 9)	h <sub>FE</sub>	300	475	—	—	I <sub>C</sub> = -10mA, V <sub>CE</sub> = -2V
		300	450	—		I <sub>C</sub> = -100mA, V <sub>CE</sub> = -2V
		150	230	—		I <sub>C</sub> = -2A, V <sub>CE</sub> = -2V
		50	70	—		I <sub>C</sub> = -4A, V <sub>CE</sub> = -2V
		15	30	—		I <sub>C</sub> = -6A, V <sub>CE</sub> = -2V
Collector-Emitter Saturation Voltage (Note 9)	V <sub>CE(sat)</sub>	—	-16	-40	mV	I <sub>C</sub> = -100mA, I <sub>B</sub> = -10mA
		—	-130	-200		I <sub>C</sub> = -1A, I <sub>B</sub> = -20mA
		—	-145	-220		I <sub>C</sub> = -1.5A, I <sub>B</sub> = -50mA
Base-Emitter Saturation Voltage (Note 9)	V <sub>BE(sat)</sub>	—	-0.87	-1	V	I <sub>C</sub> = -1.5A, I <sub>B</sub> = -50mA
Base-Emitter Turn-on Voltage (Note 9)	V <sub>BE(on)</sub>	—	-0.81	-1	V	I <sub>C</sub> = -2A, V <sub>CE</sub> = -2V
Transitional Frequency	f <sub>T</sub>	150	180	—	MHz	I <sub>C</sub> = -50mA, V <sub>CE</sub> = -10V, f = 100MHz
Output Capacitance	C <sub>obo</sub>	—	21	30	pF	V <sub>EB</sub> = -10V, f = 1MHz
Switching Time	t <sub>on</sub>	—	40	—	ns	V <sub>CC</sub> = -10V, I <sub>C</sub> = -1A,
	t <sub>off</sub>	—	670	—	ns	I <sub>B1</sub> = -I <sub>B2</sub> = -20mA

Note: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

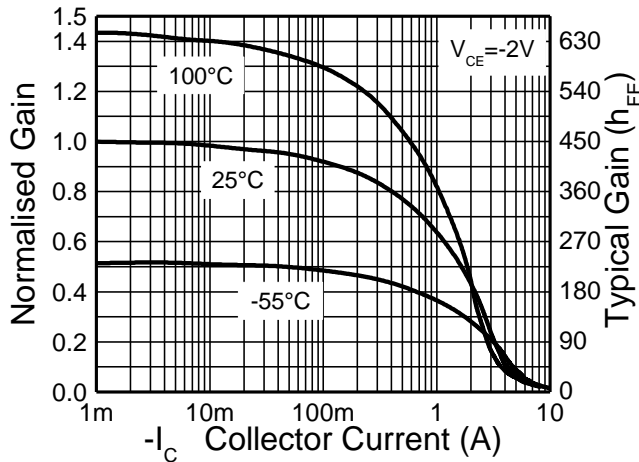
**PNP - Typical Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



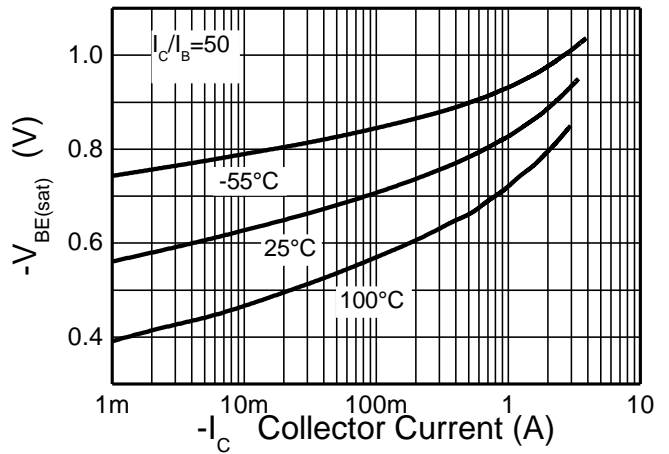
**Fig.11**  $V_{CE(sat)} \ v \ I_C$



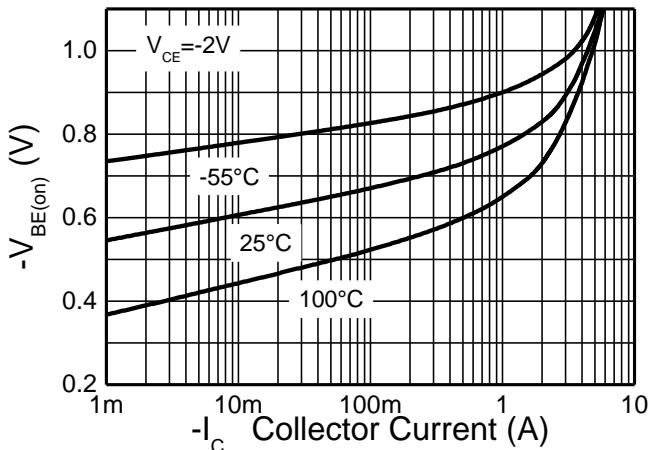
**Fig.12**  $V_{CE(sat)} \ v \ I_C$



**Fig.13**  $h_{FE} \ v \ I_C$



**Fig.14**  $V_{BE(sat)} \ v \ I_C$

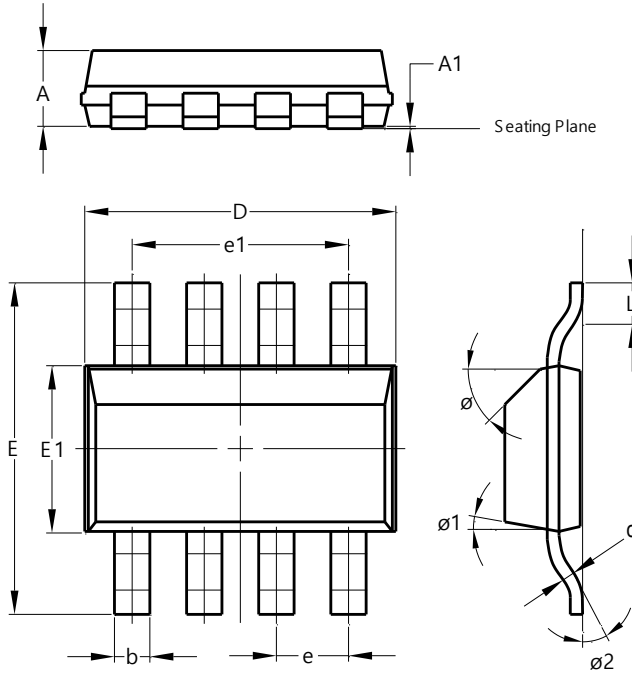


**Fig.15**  $V_{BE(on)} \ v \ I_C$

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SM-8**

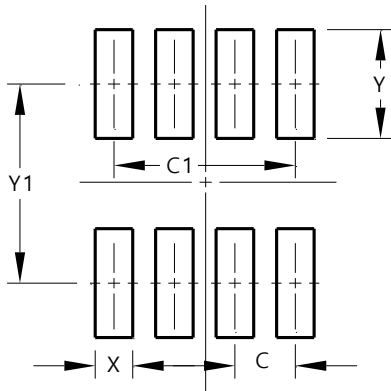


SM-8			
Dim	Min	Max	Typ
A	--	1.70	1.60
A1	0.02	0.10	0.04
b	0.70	0.90	0.80
c	0.24	0.32	0.28
D	6.30	6.70	6.60
e	1.53 REF		
e1	4.59 REF		
E	6.70	7.30	7.00
E1	3.30	3.70	3.50
L	0.75	1.00	0.90
Ø	--	--	45°
Ø1	--	15°	--
Ø2	--	--	10°
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SM-8**



Dimensions	Value (in mm)
C	1.52
C1	4.60
X	0.95
Y	2.80
Y1	6.80



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